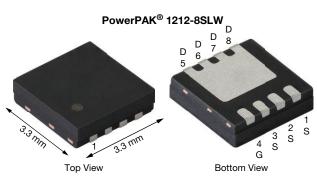
SQS135ELNW

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Vishay Siliconix

Automotive P-Channel 30 V (D-S) 175 °C MOSFET

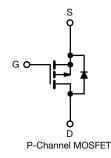


Marking code: Q085

PRODUCT SUMMARY				
V _{DS} (V)	-30			
$R_{DS(on)} (\Omega)$ at $V_{GS} = -10 V$	0.0205			
$R_{DS(on)}$ (Ω) at V_{GS} = -4.5 V	0.0536			
I _D (A) ^e	47			
Configuration	Single			

FEATURES

- TrenchFET[®] Gen IV power MOSFET
- AEC-Q101 qualified
- 100 % R_g and UIS tested
- Wettable flank terminals
- Low thermal resistance with 0.75 mm profile
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>



ORDERING INFORMATION

Package	PowerPAK [®] 1212-8SLW
Lead (Pb)-free and halogen-free	SQS135ELNW (for detailed order number please see <u>www.vishay.com/doc?79771</u>)

ABSOLUTE MAXIMUM RATINGS ($T_c = 25 \degree C$, unless otherwise noted)					
PARAMETER		SYMBOL	LIMIT	UNIT	
Drain-source voltage		V _{DS}	-30	V	
Gate-source voltage		V _{GS}	± 20	V	
Continuous drain current ^e	T _C = 25 °C	1	47		
	T _C = 125 °C	- I _D	27		
Continuous source current (diode conduction) ^e		IS	77	А	
Pulsed drain current ^{a, e}		I _{DM}	99		
Single pulse avalanche current	L = 0.1 mH	I _{AS}	21		
Single pulse avalanche energy	L = 0.1 MH	E _{AS}	23	mJ	
Maximum power dissipation ^{a, d}	T _C = 25 °C	D	84	W	
	T _C = 125 °C	P _D	28	vv	
Operating junction and storage temperature range		T _J , T _{stg}	-55 to +175	°C	
Soldering recommendations (peak temperate		260	U		

THERMAL RESISTANCE RATINGS						
PARAMETER		SYMBOL	LIMIT	UNIT		
Junction-to-ambient	PCB mount ^b	R _{thJA}	54	°C/W		
Junction-to-case (drain) ^d		R _{thJC}	1.77	0/10		

Notes

a. Pulse test; pulse width \leq 300 µs, duty cycle \leq 2 %

b. When mounted on 1" square PCB (FR4 material)

- c. See solder profile (<u>www.vishay.com/doc?73257</u>). A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection
- d. As per on JESD51-14
- e. Values based on R_{thJC} and T_C of 25 °C. Actual values achievable will dependent on the thermal characteristics of the complete system

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PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							•
Drain-source breakdown voltage	V _{DS}	V _{GS}	= 0, I _D = 250 μA	-30	-	-	v
Gate-source threshold voltage	V _{GS(th)}	V _{DS} =	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$		-2.0	-2.5	V
Gate-source leakage	I _{GSS}	V _{DS} =	0 V, $V_{GS} = \pm 20 V$	-	-	± 100	nA
	ero gate voltage drain current I_{DSS} $V_{GS} = 0 V$ $V_{DS} = -30 V$ $V_{GS} = 0 V$ $V_{DS} = -30 V$, $T_J = 125 \degree C$	-	-	1			
Zero gate voltage drain current		$V_{GS} = 0 V$	V_{DS} = -30 V, T_{J} = 125 °C	-	-	-50	μA
		$V_{GS} = 0 V$	$V_{DS} = -30 \text{ V}, \text{ T}_{J} = 175 ^{\circ}\text{C}$	-	-	-150	
On-state drain current ^a	I _{D(on)}	V _{GS} = -10 V	$V_{DS} < -5 V$	-20	-	-	А
		V _{GS} = -10 V	1 10 4	-	0.016	0.0205	
		V _{GS} = -4.5 V	I _D = -10 A	-	0.0397	0.0536	
Drain-source on-state resistance ^a	R _{DS(on)}	V _{GS} = -10 V	I _D = -10 A, T _J = 125 °C	-	-	0.0318	Ω
		V _{GS} = -10 V	I _D = -10 A, T _J = 175 °C	-	-	0.0385	1
Forward transconductance b	9 _{fs}	V _{DS} =	15 V, I _D = -30 A	-	24	-	S
Dynamic ^b	•	•			•		
Input capacitance	C _{iss}		V _{DS} = -15 V, f = 1 MHz	-	1264	1770	pF
Output capacitance	C _{oss}	$V_{GS} = 0 V$		-	272	381	
Reverse transfer capacitance	C _{rss}			-	178	250	
Total gate charge ^c	Qg			-	29	43	
Gate-source charge ^c	Q _{gs}	V _{GS} = -10 V	$V_{DS} = -15 \text{ V}, \text{ I}_{D} = -5 \text{ A}$	-	5	-	nC
Gate-drain charge ^c	Q _{gd}			-	7	-	
Gate resistance	R _g		f = 1 MHz	1.8	3.7	5.6	Ω
Turn-on delay time ^c	t _{d(on)}			-	11	17	
Rise time ^c	t _r	- Vnn =	= -15 V, R _L = 15 Ω	-	4	8	
Turn-off delay time ^c	t _{d(off)}		$V_{\text{GEN}} = -10$ V, $R_{\text{g}} = 1 \Omega$	-	34	51	ns
Fall time ^c	t _f			-	8	12	1
Source-Drain Diode Ratings and Charac	cteristic ^b						
Pulsed current ^a	I _{SM}			-	-	99	Α
Forward voltage	V _{SD}	I _F = -10 A, V _{GS} = 0 V		-	0.82	1.1	V
Body diode reverse recovery time	t _{rr}			-	21	42	ns
Body diode reverse recovery charge	Q _{rr}		-24 V, I _{FM} = -17 A,	-	14	27	nC
Reverse recovery fall time	t _a	di/dt = 100 A/ μ s, R = 10 Ω , L = 0.3 mH, pulse width = 2 μ s		-	12	-	1
Reverse recovery rise time	t _b			-	10	-	ns
Body diode peak reverse recovery current	I _{RM(REC)}			-	-1.25	-	А

Notes

a. Pulse test; pulse width $\leq 300~\mu s,~duty~cycle \leq 2~\%$

b. Guaranteed by design, not subject to production testing

c. Independent of operating temperature

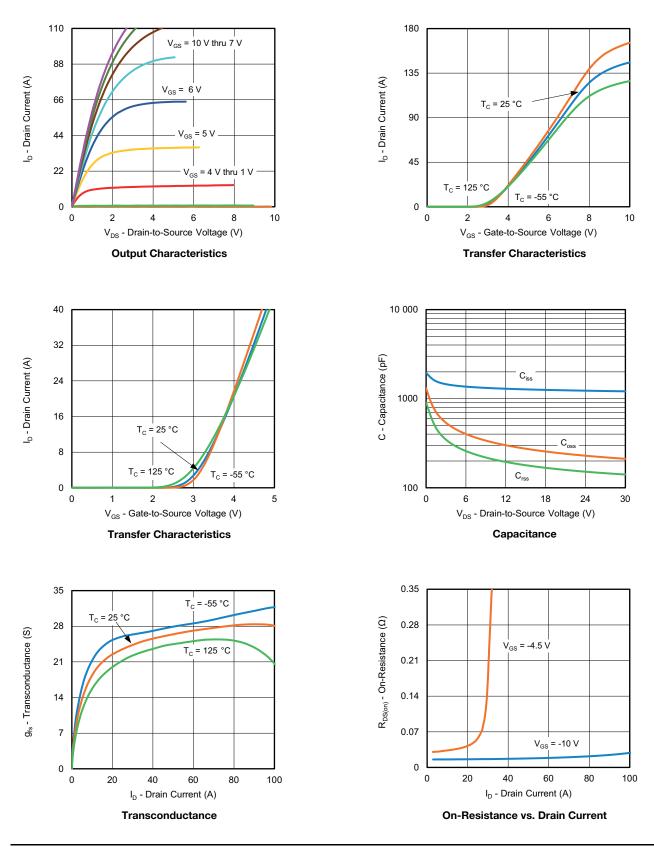
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

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TYPICAL CHARACTERISTICS (T_A = 25 °C, unless otherwise noted)



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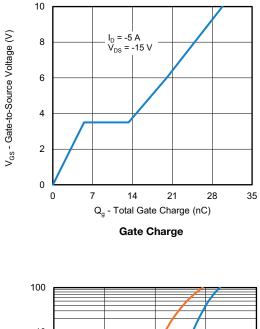
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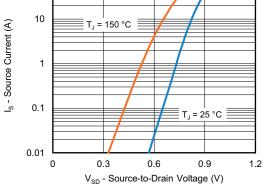
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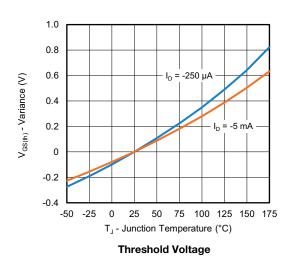
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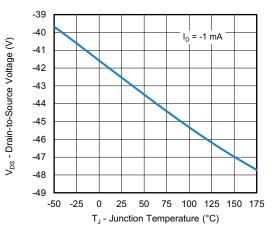
TYPICAL CHARACTERISTICS ($T_A = 25 \text{ °C}$, unless otherwise noted)



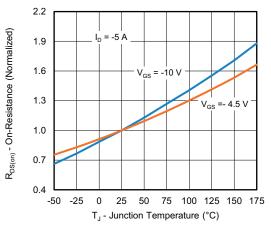


Source Drain Diode Forward Voltage

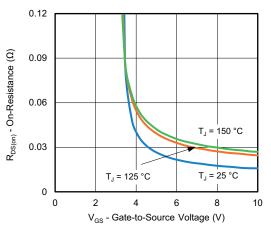




Drain Source Breakdown vs. Junction Temperature



On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

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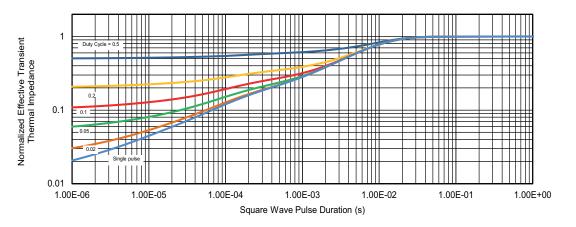
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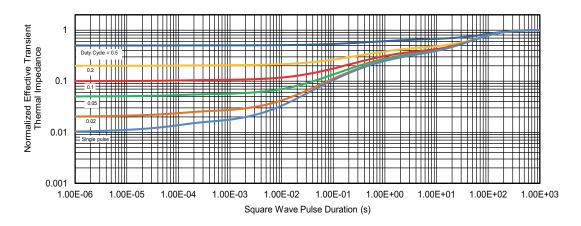


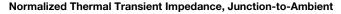
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THERMAL RATINGS (T_A = 25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Case





Note

- The characteristics shown in the two graphs
 - Normalized Transient Thermal Impedance Junction-to-Ambient (25 °C)
 - Normalized Transient Thermal Impedance Junction-to-Case (25 °C)

are given for general guidelines only to enable the user to get a "ball park" indication of part capabilities. The data are extracted from single pulse transient thermal impedance characteristics which are developed from empirical measurements. The latter is valid for the part mounted on printed circuit board - FR4, size 1" x 1" x 0.062", double sided with 2 oz. copper, 100 % on both sides. The part capabilities can widely vary depending on actual application parameters and operating conditions

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